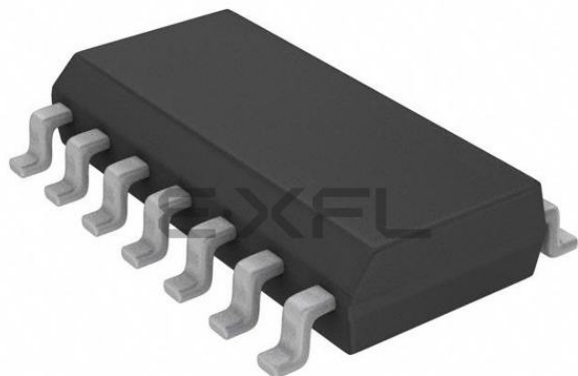




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What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	I ² C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	12
Program Memory Size	28KB (16K x 14)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 5.5V
Data Converters	A/D 11x12b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	14-SOIC (0.154", 3.90mm Width)
Supplier Device Package	14-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f18426-e-sl

- 256B Data EEPROM
- Direct, Indirect and Relative Addressing modes
- Memory Access Partition (MAP):
 - Write-protect
 - Customizable partition
- Device Information Area (DIA)
- Device Configuration Information (DCI)

Operating Characteristics

- Operating Voltage Range:
 - 1.8V to 3.6V (PIC16LF184XX)
 - 2.3V to 5.5V (PIC16F184XX)
- Temperature Range:
 - Industrial: -40°C to 85°C
 - Extended: -40°C to 125°C

Power-Saving Operation Modes

- Doze: CPU and Peripherals Running at Different Cycle Rates (typically CPU is lower)
- Idle: CPU Halted While Peripherals Operate
- Sleep: Lowest Power Consumption
- Peripheral Module Disable (PMD):
 - Ability to selectively disable hardware module to minimize active power consumption of unused peripherals
- Extreme Low-Power mode (XLP)
 - Sleep: 500 nA typical @ 1.8V
 - Sleep and Watchdog Timer: 900 nA typical @ 1.8V

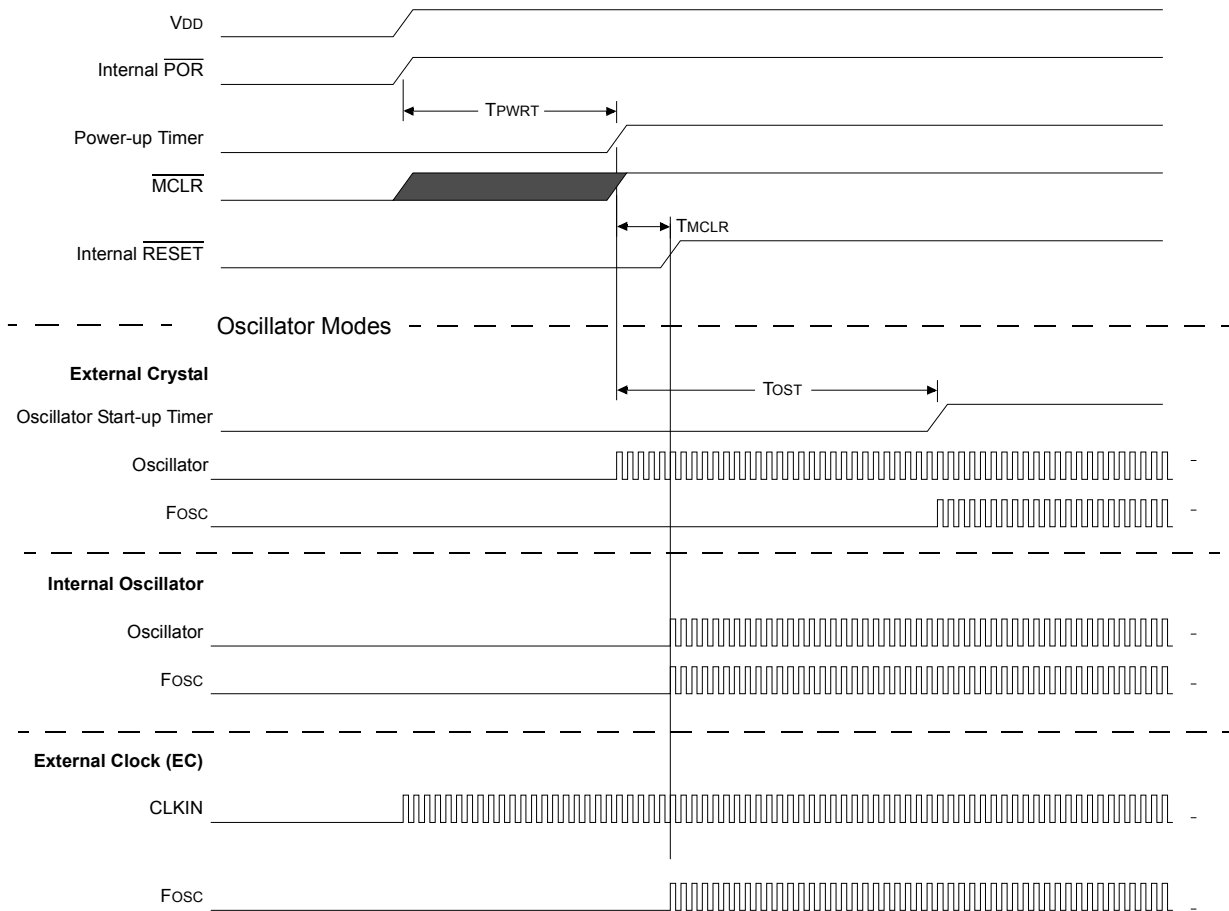
eXtreme Low-Power (XLP) Features

- Sleep mode: 50 nA @ 1.8, typical
- Watchdog Timer: 500 nA @ 1.8V, typical
- Secondary Oscillator: 500 nA @ 32 kHz
- Operating Current:
 - 8 uA @ 32 kHz, 1.8V, typical
 - 32 uA/MHz @ 1.8V, typical

Digital Peripherals

- Configurable Logic Cell (CLC):
 - 4 CLCs
 - Integrated combinational and sequential logic
- Complementary Waveform Generator (CWG):
 - 2 CWGs

Figure 8-4. Reset Start-up Sequence

Rev. 30-00000A
4/12/2017**Related Links**

[Oscillator Module \(with Fail-Safe Clock Monitor\)](#)

8.11 Memory Execution Violation

A Memory Execution Violation Reset occurs if executing an instruction being fetched from outside the valid execution area. The different valid execution areas are defined as follows:

- Flash Memory: The “*Device Sizes and Addresses*” table shows the addresses available on the PIC16(L)F18426/46 devices based on user Flash size. Execution outside this region generates a memory execution violation.
- Storage Area Flash (SAF): If Storage Area Flash (SAF) is enabled, the SAF area is not a valid execution area.

Prefetched instructions that are not executed do not cause memory execution violations. For example, a GOTO instruction in the last memory location will prefetch from an invalid location; this is not an error. If an instruction from an invalid location tries to execute, the memory violation is generated immediately, and any concurrent interrupt requests are ignored. When a memory execution violation is generated, the device is reset and flag **MEMV** is cleared in PCON1 to signal the cause. The flag needs to be set in code after a memory execution violation.

Related Links

Condition	Program Counter	STATUS Register	PCON0 Register	PCON1 Register
Interrupt Wake-up from Sleep	PC + 1 ⁽¹⁾	---1 0uuu	uuuu uuuu	---- --u-
RESET Instruction Executed	0	---u uuuu	uuuu u0uu	---- --u-
Stack Overflow Reset (STVREN = 1)	0	---u uuuu	1uuu uuuu	---- --u-
Stack Underflow Reset (STVREN = 1)	0	---u uuuu	u1uu uuuu	---- --u-
Memory Violation Reset ($\overline{\text{MEMV}}$ = 0)	0	-uuu uuuu	uuuu uuuu	---- --0-

Legend: u = unchanged, x = unknown, — = unimplemented bit, reads as '0'.

Note:

1. When the wake-up is due to an interrupt and Global Enable bit (GIE) is set, the return address is pushed on the stack and PC is loaded with the interrupt vector (0004h) after execution of PC + 1.

Related Links

[STATUS](#)

8.13 Power Control (PCONx) Register

The Power Control (PCONx) registers contain flag bits to differentiate between a:

- Brown-out Reset ($\overline{\text{BOR}}$)
- Power-on Reset ($\overline{\text{POR}}$)
- Reset Instruction Reset ($\overline{\text{RI}}$)
- $\overline{\text{MCLR}}$ Reset ($\overline{\text{RMCLR}}$)
- Watchdog Timer Reset ($\overline{\text{RWD\overline{T}}}$)
- Watchdog Window Violation ($\overline{\text{WDTWV}}$)
- Stack Underflow Reset (STKUNF)
- Stack Overflow Reset (STKOVF)
- Memory Violation Reset ($\overline{\text{MEMV}}$)

Hardware will change the corresponding register bit during the Reset process; if the Reset was not caused by the condition, the bit remains unchanged.

Software should reset the bit to the inactive state after restart (hardware will not reset the bit).

Software may also set any PCONx bit to the active state, so that user code may be tested, but no Reset action will be generated.

Related Links

[Determining the Cause of a Reset](#)

[PCON0](#)

[PCON1](#)

10. Interrupts

The interrupt feature allows certain events to preempt normal program flow. Firmware is used to determine the source of the interrupt and act accordingly. Some interrupts can be configured to wake the MCU from Sleep mode.

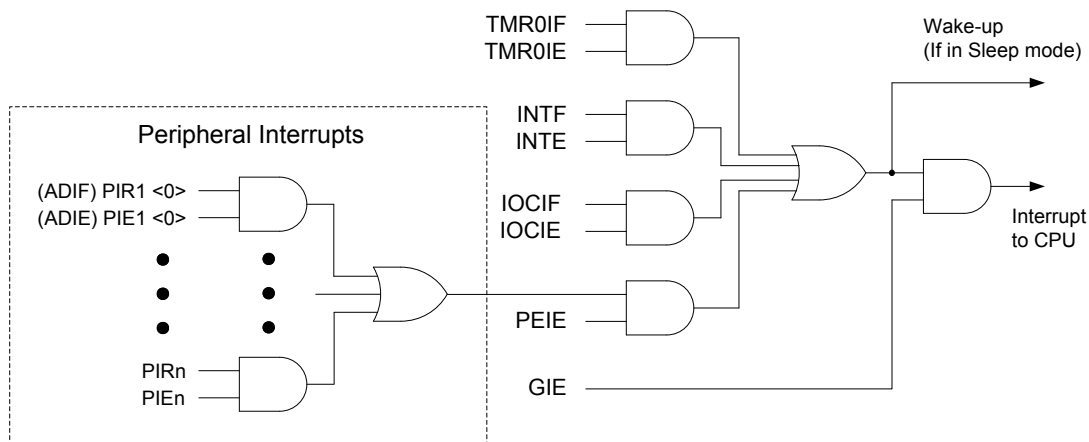
This chapter contains the following information for Interrupts:

- Operation
- Interrupt Latency
- Interrupts During Sleep
- INT Pin
- Automatic Context Saving

Many peripherals produce interrupts. Refer to the corresponding chapters for details.

A block diagram of the interrupt logic is shown below.

Figure 10-1. Interrupt Logic



10.1 Operation

Interrupts are disabled upon any device Reset. They are enabled by setting the following bits:

- GIE bit of the INTCON register
- Interrupt Enable bit(s) of the PIRx[y] registers for the specific interrupt event(s)
- PEIE bit of the INTCON register (if the Interrupt Enable bit of the interrupt event is contained in the PIRx registers)

The PIR registers contain the individual flag bits for the peripheral interrupts. Due to the number of peripheral interrupt sources, there are 9 PIR registers.

The following events happen when an interrupt event occurs while the GIE bit is set:

- Current prefetched instruction is flushed
- GIE bit is cleared
- Current Program Counter (PC) is pushed onto the stack

10.7.1 INTCON

Name: INTCON**Address:** 0x00B

Interrupt Control Register

Bit	7	6	5	4	3	2	1	0
	GIE	PEIE						INTEDG
Access	R/W	R/W						R/W
Reset	0	0						1

Bit 7 – GIE Global Interrupt Enable bit

Value	Description
1	Enables all active interrupts
0	Disables all interrupts

Bit 6 – PEIE Peripheral Interrupt Enable bit

Value	Description
1	Enables all active peripheral interrupts
0	Disables all peripheral interrupts

Bit 0 – INTEDG External Interrupt Edge Select bit

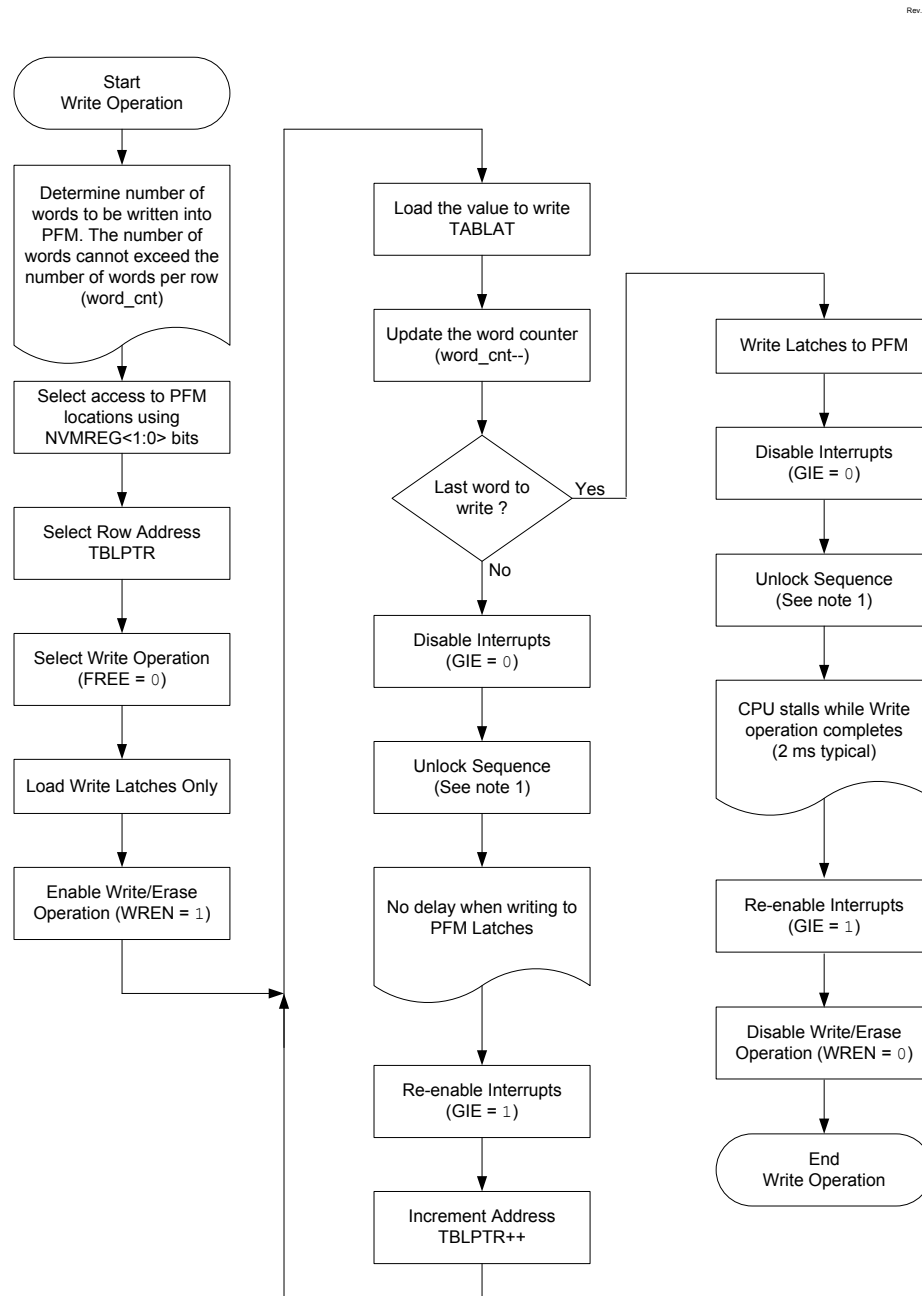
Value	Description
1	Interrupt on rising edge of INT pin
0	Interrupt on falling edge of INT pin

Important: Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the global enable bit. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt. This feature allows for software polling.

Value	Description
1	Enabled
0	Disabled

Note: Bit PEIE of the INTCON register must be set to enable any peripheral interrupt controlled by registers PIE1-PIE8.

Figure 13-5. Program Flash Memory Flowchart



Note:

1. See [NVM Unlock Sequence Flowchart](#)

Writing to Program Flash Memory

```

; This write routine assumes the following:
; 1. 64 bytes of data are loaded, starting at the address in DATA_ADDR
; 2. Each word of data to be written is made up of two adjacent bytes in
DATA_ADDR,
; stored in little endian format
; 3. A valid starting address (the least significant bits = 00000) is
  
```

14.6.1 PORTA

Name: PORTA

Address: 0x00C

PORTA Register

Bit	7	6	5	4	3	2	1	0
			RA5	RA4	RA3	RA2	RA1	RA0
Access			R/W	R/W	R/W	R/W	R/W	R/W
Reset			x	x	x	x	x	x

Bits 0, 1, 2, 3, 4, 5 – RAn Port I/O Value bits

Reset States: POR/BOR = xxxxxx

All Other Resets = uuuuuu

Value	Description
1	Port pin is $\geq V_{IH}$
0	Port pin is $\leq V_{IL}$

Note:

- Writes to PORTA are actually written to the corresponding LATA register.
Reads from PORTA register return actual I/O pin values.
- Bits RA0, RA1 and RA3 are read-only when $\overline{\text{DEBUG}}$ is enabled, and will read '0'.
- Bit RA3 will read '1' when MCLRE = 1 (master clear enabled) and '0' when $\overline{\text{DEBUG}}$ is enabled.

17.6.9 IOCCF

Name: IOCCF
Address: 0x1F55

PORTC Interrupt-on-Change Flag Register

Bit	7	6	5	4	3	2	1	0
	IOCCF7	IOCCF6	IOCCF5	IOCCF4	IOCCF3	IOCCF2	IOCCF1	IOCCF0
Access	R/W/HS	R/W/HS	R/W/HS	R/W/HS	R/W/HS	R/W/HS	R/W/HS	R/W/HS
Reset	0	0	0	0	0	0	0	0

Bits 0, 1, 2, 3, 4, 5, 6, 7 – IOCCFn Interrupt-on-Change Flag bits

Value	Condition	Description
1	IOCCP[n]=1	A positive edge was detected on the RC[n] pin
1	IOCCN[n]=1	A negative edge was detected on the RC[n] pin
0	IOCCP[n]=x and IOCCN[n]=x	No change was detected, or the user cleared the detected change

Note: IOCCF6 and IOCCF7 are available on 20-pin or higher pin-count devices only.

25.1 Timer0 Operation

Timer0 can operate as either an 8-bit or 16-bit timer. The mode is selected with the [T016BIT](#) bit.

25.1.1 8-bit Mode

In this mode Timer0 increments on the rising edge of the selected clock source. A prescaler on the clock input gives several prescale options (see prescaler control bits, [T0CKPS](#)).

In this mode as shown in the [8-bit TMR0 Body Diagram](#), a buffered version of TMR0H is maintained. This is compared with the value of TMR0L on each cycle of the selected clock source. When the two values match, the following events occur:

- TMR0L is reset
- The contents of TMR0H are copied to the TMR0H buffer for next comparison

25.1.2 16-Bit Mode

In this mode Timer0 increments on the rising edge of the selected clock source. A prescaler on the clock input gives several prescale options (see prescaler control bits, [T0CKPS](#)).

In this mode TMR0H:TMR0L form the 16-bit timer value. As shown in the [16-bit TMR0 Body Diagram](#), read and write of the TMR0H register are buffered. TMR0H register is updated with the contents of the high byte of Timer0 during a read of TMR0L register. Similarly, a write to the high byte of Timer0 takes place through the TMR0H buffer register. The high byte is updated with the contents of TMR0H register when a write occurs to TMR0L register. This allows all 16 bits of Timer0 to be read and written at the same time.

Timer 0 rolls over to 0x0000 on incrementing past 0xFFFF. This makes the timer free running. TMR0L/H registers cannot be reloaded in this mode once started.

25.2 Clock Selection

Timer0 has several options for clock source selections, option to operate synchronously/asynchronously and a programmable prescaler.

25.2.1 Clock Source Selection

The [T0CS](#) bits are used to select the clock source for Timer0. The possible clock sources are listed in the table below.

Table 25-1. Timer0 Clock Source Selections

T0CS	Clock Source
111	CLC1_out
110	SOSC
101	MFINTOSC(500 kHz)
100	LFINTOSC
011	HFINTOSC
010	F _{osc} /4

27.9.4 TxHLT

Name: TxHLT**Address:** 0x28F,0x295,0x29B

Timer Hardware Limit Control Register

Bit	7	6	5	4	3	2	1	0
	PSYNC	CPOL	CSYNC	MODE[4:0]				
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit 7 – PSYNCTimer Prescaler Synchronization Enable bit^(1, 2)

Value	Description
1	Timer Prescaler Output is synchronized to $F_{OSC}/4$
0	Timer Prescaler Output is not synchronized to $F_{OSC}/4$

Bit 6 – CPOLTimer Clock Polarity Selection bit⁽³⁾

Value	Description
1	Falling edge of input clock clocks timer/prescaler
0	Rising edge of input clock clocks timer/prescaler

Bit 5 – CSYNCTimer Clock Synchronization Enable bit^(4, 5)

Value	Description
1	ON bit is synchronized to timer clock input
0	ON bit is not synchronized to timer clock input

Bits 4:0 – MODE[4:0]Timer Control Mode Selection bits^(6, 7)

Value	Description
00000 to 11111	See Table 27-3

Note:

- Setting this bit ensures that reading TxTMR will return a valid data value.
- When this bit is '1', Timer cannot operate in Sleep mode.
- CKPOL should not be changed while ON = 1.
- Setting this bit ensures glitch-free operation when the ON is enabled or disabled.
- When this bit is set then the timer operation will be delayed by two input clocks after the ON bit is set.
- Unless otherwise indicated, all modes start upon ON = 1 and stop upon ON = 0 (stops occur without affecting the value of TxTMR).

28. CCP/PWM Timer Resource Selection

Each CCP/PWM module has an independent timer selection which can be accessed using the CxTSEL or PxTSEL bits in the [CCPTMRS0](#) and/or [CCPTMRS1](#) registers. The default timer selection is TMR1 when using Capture/Compare mode and T2TMR when using PWM mode in the CCPx module. The default timer selection for the PWM module is always T2TMR.

The CLCxIF bit of the associated PIR register will be set when either edge detector is triggered and its associated enable bit is set. The [INTP](#) enables rising edge interrupts and the [INTN](#) bit enables falling edge interrupts.

To fully enable the interrupt, set the following bits:

- CLCxIE bit of the respective PIE register
- [INTP](#) bit (for a rising edge detection)
- [INTN](#) bit (for a falling edge detection)
- If priority interrupts are not used
 - Clear the IPEN bit of the INTCON register
 - Set the GIE bit of the INTCON register
 - Set the PEIE bit of the INTCON register
- If the CLC is a high priority interrupt
 - Set the IPEN bit of the INTCON register
 - Set the CLCxIP bit of the respective IPR register
 - Set the GIEH bit of the INTCON register
- If the CLC is a low priority interrupt
 - Set the IPEN bit of the INTCON register
 - Clear the CLCxIP bit of the respective IPR register
 - Set the GIEL bit of the INTCON register

The CLCxIF bit of the respective PIR register, must be cleared in software as part of the interrupt service. If another edge is detected while this flag is being cleared, the flag will still be set at the end of the sequence.

Related Links

[INTCON](#)

[PIE5](#)

[PIR5](#)

33.3 Output Mirror Copies

Mirror copies of all CLCxOUT bits are contained in the [CLCDATA](#) register. Reading this register reads the outputs of all CLCs simultaneously. This prevents any reading skew introduced by testing or reading the OUT bits in the individual CLCxCON registers.

33.4 Effects of a Reset

The CLCxCON register is cleared to zero as the result of a Reset. All other selection and gating values remain unchanged.

33.5 Operation During Sleep

The CLC module operates independently from the system clock and will continue to run during Sleep, provided that the input sources selected remain active.

The HFINTOSC remains active during Sleep when the CLC module is enabled and the HFINTOSC is selected as an input source, regardless of the system clock source selected.

The clock divider values can be changed while the module is enabled. However, in order to prevent glitches on the output, the **DIV** bits should only be changed when the module is disabled (**EN** = 0).

34.3 Selectable Duty Cycle

The **DC** bits are used to modify the duty cycle of the output clock. A duty cycle of 0%, 25%, 50%, or 75% can be selected for all clock rates when the **DIV** value is not 0b000. When **DIV**=0b000 then the duty cycle defaults to 50% for all values of **DC** except 0b00 in which case the duty cycle is 0% (constant low output).

The duty cycle can be changed while the module is enabled. However, in order to prevent glitches on the output, the **DC** bits should only be changed when the module is disabled (**EN** = 0).



Important: The **DC** value at reset is 10. This makes the default duty cycle 50% and not 0%.

34.4 Operation in Sleep Mode

The reference clock module continues to operate and provide a signal output in Sleep for all clock source selections except F_{OSC} (**CLK**=0).

35.6.1 I²C Master Mode Operation

The master device generates all of the serial clock pulses and the Start and Stop conditions. A transfer is ended with a Stop condition or with a Repeated Start condition. Since the Repeated Start condition is also the beginning of the next serial transfer, the I²C bus will not be released.

In Master Transmitter mode, serial data is output through SDA, while SCL outputs the serial clock. The first byte transmitted contains the slave address of the receiving device (7 bits) and the R/W bit. In this case, the R/W bit will be logic '0'. Serial data is transmitted eight bits at a time. After each byte is transmitted, an Acknowledge bit is received. Start and Stop conditions are output to indicate the beginning and the end of a serial transfer.

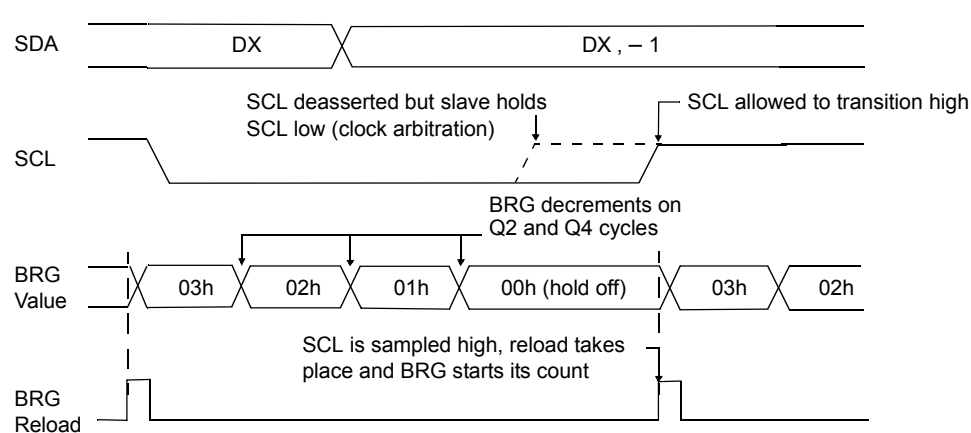
In Master Receive mode, the first byte transmitted contains the slave address of the transmitting device (7 bits) and the R/W bit. In this case, the R/W bit will be logic '1'. Thus, the first byte transmitted is a 7-bit slave address followed by a '1' to indicate the receive bit. Serial data is received via SDA, while SCL outputs the serial clock. Serial data is received eight bits at a time. After each byte is received, an Acknowledge bit is transmitted. Start and Stop conditions indicate the beginning and end of transmission.

A Baud Rate Generator is used to set the clock frequency output on SCL. See [Baud Rate Generator](#) for more detail.

35.6.2 Clock Arbitration

Clock arbitration occurs when the master, during any receive, transmit or Repeated Start/Stop condition, releases the SCL pin (SCL allowed to float high). When the SCL pin is allowed to float high, the Baud Rate Generator (BRG) is suspended from counting until the SCL pin is actually sampled high. When the SCL pin is sampled high, the Baud Rate Generator is reloaded with the contents of [SSPxADD](#) and begins counting. This ensures that the SCL high time will always be at least one BRG rollover count in the event that the clock is held low by an external device as shown in the following figure.

Figure 35-25. Baud Rate Generator Timing with Clock Arbitration



35.6.3 WCOL Status Flag

If the user writes the SSPxBUF when a Start, Restart, Stop, Receive or Transmit sequence is in progress, the WCOL bit is set and the contents of the buffer are unchanged (the write does not occur). Any time the WCOL bit is set it indicates that an action on SSPxBUF was attempted while the module was not idle.

PIC16(L)F18426/46

Register Summary

Offset	Name	Bit Pos.								
0x0C0A	PCLATH	7:0		PCLATH[6:0]						
0x0C0B	INTCON	7:0	GIE	PEIE						INTEDG
0x0C0C ... 0x0C7F	Reserved									
0x0C80	INDF0	7:0	INDF0[7:0]							
0x0C81	INDF1	7:0	INDF1[7:0]							
0x0C82	PCL	7:0	PCL[7:0]							
0x0C83	STATUS	7:0				TO	PD	Z	DC	C
0x0C84	FSR0	7:0	FSRL[7:0]							
		15:8	FSRH[7:0]							
0x0C86	FSR1	7:0	FSRL[7:0]							
		15:8	FSRH[7:0]							
0x0C88	BSR	7:0			BSR[5:0]					
0x0C89	WREG	7:0	WREG[7:0]							
0x0C8A	PCLATH	7:0		PCLATH[6:0]						
0x0C8B	INTCON	7:0	GIE	PEIE						INTEDG
0x0C8C ... 0x0CFF	Reserved									
0x0D00	INDF0	7:0	INDF0[7:0]							
0x0D01	INDF1	7:0	INDF1[7:0]							
0x0D02	PCL	7:0	PCL[7:0]							
0x0D03	STATUS	7:0				TO	PD	Z	DC	C
0x0D04	FSR0	7:0	FSRL[7:0]							
		15:8	FSRH[7:0]							
0x0D06	FSR1	7:0	FSRL[7:0]							
		15:8	FSRH[7:0]							
0x0D08	BSR	7:0			BSR[5:0]					
0x0D09	WREG	7:0	WREG[7:0]							
0x0D0A	PCLATH	7:0		PCLATH[6:0]						
0x0D0B	INTCON	7:0	GIE	PEIE						INTEDG
0x0D0C ... 0x0D7F	Reserved									
0x0D80	INDF0	7:0	INDF0[7:0]							
0x0D81	INDF1	7:0	INDF1[7:0]							
0x0D82	PCL	7:0	PCL[7:0]							
0x0D83	STATUS	7:0				TO	PD	Z	DC	C
0x0D84	FSR0	7:0	FSRL[7:0]							
		15:8	FSRH[7:0]							
0x0D86	FSR1	7:0	FSRL[7:0]							
		15:8	FSRH[7:0]							
0x0D88	BSR	7:0			BSR[5:0]					
0x0D89	WREG	7:0	WREG[7:0]							
0x0D8A	PCLATH	7:0		PCLATH[6:0]						

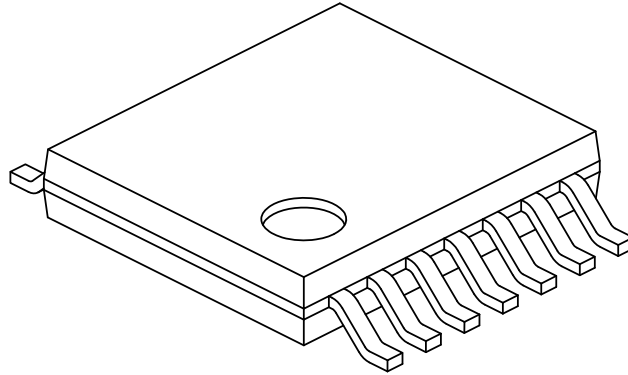
PIC16(L)F18426/46

Register Summary

Offset	Name	Bit Pos.								
0x168B	INTCON	7:0	GIE	PEIE						INTEDG
0x168C ... 0x16FF	Reserved									
0x1700	INDF0	7:0	INDF0[7:0]							
0x1701	INDF1	7:0	INDF1[7:0]							
0x1702	PCL	7:0	PCL[7:0]							
0x1703	STATUS	7:0				TO	PD	Z	DC	C
0x1704	FSR0	7:0	FSRL[7:0]							
		15:8	FSRH[7:0]							
0x1706	FSR1	7:0	FSRL[7:0]							
		15:8	FSRH[7:0]							
0x1708	BSR	7:0			BSR[5:0]					
0x1709	WREG	7:0	WREG[7:0]							
0x170A	PCLATH	7:0		PCLATH[6:0]						
0x170B	INTCON	7:0	GIE	PEIE						INTEDG
0x170C ... 0x177F	Reserved									
0x1780	INDF0	7:0	INDF0[7:0]							
0x1781	INDF1	7:0	INDF1[7:0]							
0x1782	PCL	7:0	PCL[7:0]							
0x1783	STATUS	7:0				TO	PD	Z	DC	C
0x1784	FSR0	7:0	FSRL[7:0]							
		15:8	FSRH[7:0]							
0x1786	FSR1	7:0	FSRL[7:0]							
		15:8	FSRH[7:0]							
0x1788	BSR	7:0			BSR[5:0]					
0x1789	WREG	7:0	WREG[7:0]							
0x178A	PCLATH	7:0		PCLATH[6:0]						
0x178B	INTCON	7:0	GIE	PEIE						INTEDG
0x178C ... 0x17FF	Reserved									
0x1800	INDF0	7:0	INDF0[7:0]							
0x1801	INDF1	7:0	INDF1[7:0]							
0x1802	PCL	7:0	PCL[7:0]							
0x1803	STATUS	7:0				TO	PD	Z	DC	C
0x1804	FSR0	7:0	FSRL[7:0]							
		15:8	FSRH[7:0]							
0x1806	FSR1	7:0	FSRL[7:0]							
		15:8	FSRH[7:0]							
0x1808	BSR	7:0			BSR[5:0]					
0x1809	WREG	7:0	WREG[7:0]							
0x180A	PCLATH	7:0		PCLATH[6:0]						
0x180B	INTCON	7:0	GIE	PEIE						INTEDG

14-Lead Plastic Thin Shrink Small Outline (ST) - 4.4 mm Body [TSSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N	14		
Pitch	e	0.65 BSC		
Overall Height	A	-	-	1.20
Molded Package Thickness	A2	0.80	1.00	1.05
Standoff	A1	0.05	-	0.15
Overall Width	E	6.40 BSC		
Molded Package Width	E1	4.30	4.40	4.50
Molded Package Length	D	4.90	5.00	5.10
Foot Length	L	0.45	0.60	0.75
Footprint	(L1)	1.00 REF		
Foot Angle	φ	0°	-	8°
Lead Thickness	c	0.09	-	0.20
Lead Width	b	0.19	-	0.30

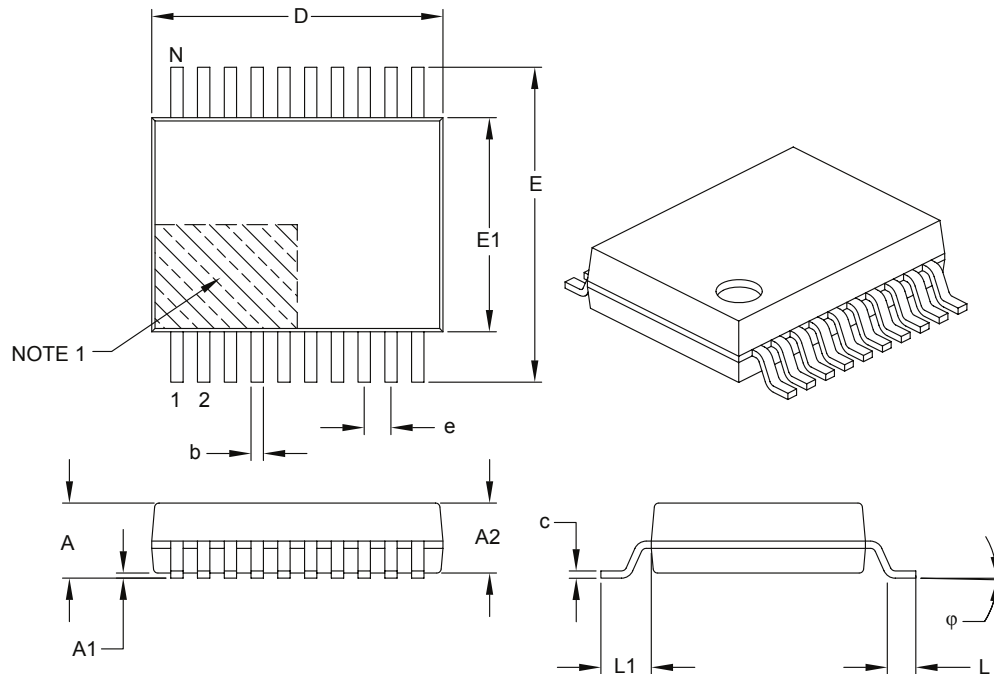
Notes:

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15mm per side.
- Dimensioning and tolerancing per ASME Y14.5M
 - BSC: Basic Dimension. Theoretically exact value shown without tolerances.
 - REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing No. C04-087C Sheet 2 of 2

20-Lead Plastic Shrink Small Outline (SS) – 5.30 mm Body [SSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



		Units	MILLIMETERS		
Dimension Limits			MIN	NOM	MAX
Number of Pins	N		20		
Pitch	e		0.65 BSC		
Overall Height	A		–	–	2.00
Molded Package Thickness	A2		1.65	1.75	1.85
Standoff	A1		0.05	–	–
Overall Width	E		7.40	7.80	8.20
Molded Package Width	E1		5.00	5.30	5.60
Overall Length	D		6.90	7.20	7.50
Foot Length	L		0.55	0.75	0.95
Footprint	L1		1.25 REF		
Lead Thickness	c		0.09	–	0.25
Foot Angle	φ		0°	4°	8°
Lead Width	b		0.22	–	0.38

Notes:

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.20 mm per side.
- Dimensioning and tolerancing per ASME Y14.5M.

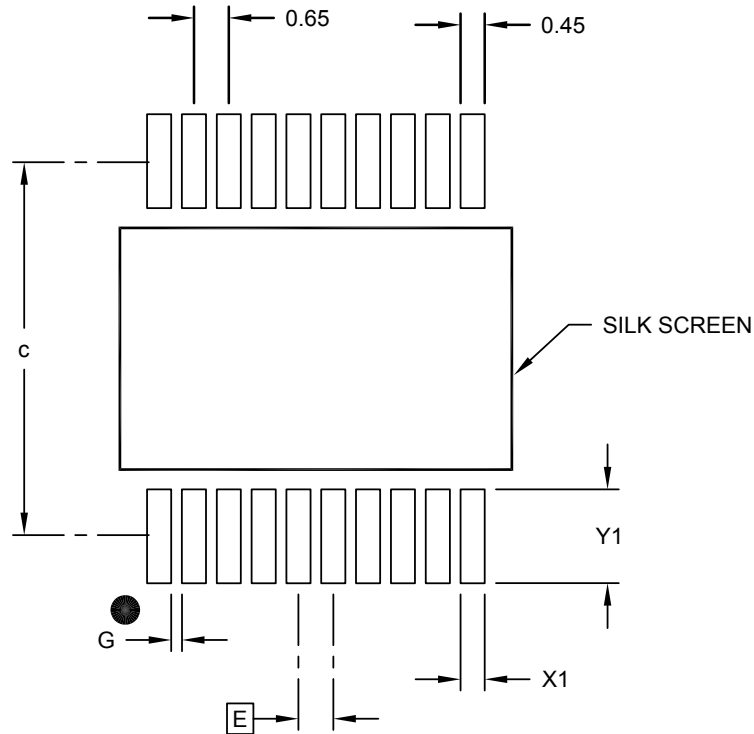
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-072B

20-Lead Plastic Shrink Small Outline (SS) - 5.30 mm Body [SSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E	0.65 BSC		
Contact Pad Spacing	C		7.20	
Contact Pad Width (X20)	X1			0.45
Contact Pad Length (X20)	Y1			1.75
Distance Between Pads	G	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2072B